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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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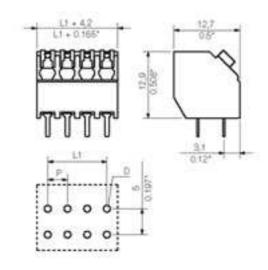
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China















General ordering data	
Order No.	1885250000
Part designation	LSF-SMT3.50/9/135 1.5
Version	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 9, 135°, Tube
EAN	4032248490134
Qty.	17 pc(s).

Product family	System LS
Conductor connection system	Push In
Fitted to PCB	Reflow solder connection
Outgoing direction of conductor	135°
Pitch	3.5 mm
Pitch in inch	0.138 inch
No. of poles	9
Fitted by customer	no
No. of rows	1
Solder pin length	1.5 mm
Dia. of fitting hole	1.1 mm
Fitting hole tolerance	+ 0.1 mm
No. of solder pins per pole	2
Stripping length	8 mm



System parameters	
L1 in mm	28 mm
L1 in inch	1.102 inch
Electric shock protection to DIN VDE 0470	IP 20
Electric shock protection to DIN VDE 0470	Safe from finger touch
Electric shock protection to Birt VBE 0470	Cale non inger touch
Material data	
Insulating material	LCP GF
Colour	black
colour chart	Similar to RAL 9011
Insulating material group	Illa
Flammability class UL 94	V-0
CTI	>= 175
Contact base material	Copper alloy
Contact surface	tinned
Storage temperature, min.	-25 °C
Storage temperature, max.	55 °C
Connectable conductors	0.40
Clamping range, min.	0.13 mm ²
Clamping range, max.	1.5 mm ²
AWG, min.	24
AWG, max.	16
O.D. of conductor insulation, max.	2.9 mm
Solid, min. H05(07) V-U	0.2 mm ²
Solid, max. H05(07) V-U	1.5 mm²
Flexible, min. H05(07) V-K	0.2 mm ²
Flexible, max. H05(07) V-K	1.5 mm²
With wire and farrula, acc. to DIN 46 228/1, min.	0.25 mm ²
With wire end ferrule, acc. to DIN 46 228/1, max.	1.5 mm ² 0.25 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, min.	0.75 mm ²
w. plastic collar ferrule, DIN 46228 pt 4, max.	0.75 111111
DIN IEC rating data	
Rated current, min. No. pins (Tu=20°C)	17.5 A
Rated current, max. No. pins (Tu=20°C)	16 A
Rated current, min. No. pins(Tu=40°C)	17.5 A
Rated current, max. No. pins (Tu=40°C)	14 A
Rated voltage for overvoltage class/pollution	320 V
severity II/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/2	
Rated voltage for overvoltage class/pollution	160 V
severity III/3	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity II/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/2	
Rated impulse withstand voltage for overvoltage	2.5 kV
class/pollution severity III/3	
Short-time withstand current resistance	3 x 1s with 80 A



300 V
10 A
24
16
300 V
10 A
24
16

Annrovals

Approvals institutes



Classifications

eClass 5.1 27-26-11-01

Similar products

LSF-SMT3.50/2/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 2, 135°, Tube
LSF-SMT3.5/2/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 2, 135°, Tape
LSF-SMT3.50/2/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 2, 135°, Tube
LSF-SMT3.5/2/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 2, 135°, Tape
LSF-SMT3.50/3/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 3, 135°, Tube
LSF-SMT3.5/3/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 3, 135°, Tape
LSF-SMT3.50/3/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 3, 135°, Tube
LSF-SMT3.5/3/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 3, 135°, Tape
LSF-SMT3.50/4/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 4, 135°, Tube
LSF-SMT3.5/4/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 4, 135°, Tape
LSF-SMT3.50/4/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 4, 135°, Tube
LSF-SMT3.5/4/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 4, 135°, Tape
	LSF-SMT3.50/2/135 3.5 LSF-SMT3.5/2/135 3.5R LSF-SMT3.50/2/135 1.5 LSF-SMT3.5/2/135 1.5R LSF-SMT3.50/3/135 3.5 LSF-SMT3.5/3/135 3.5R LSF-SMT3.5/3/135 1.5 LSF-SMT3.5/3/135 1.5R LSF-SMT3.5/3/135 3.5 LSF-SMT3.5/3/135 3.5 LSF-SMT3.5/3/135 3.5 LSF-SMT3.5/3/135 3.5 LSF-SMT3.5/4/135 3.5 LSF-SMT3.5/4/135 3.5R



1885680000	LSF-SMT3.50/5/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100710000	1.05.0MT0.5/5/405.0.5D	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 5, 135°, Tube
1887460000	LSF-SMT3.5/5/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1005210000	LOT CMT2 FO/F/12F 1 F	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 5, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range,
1885210000	LSF-SMT3.50/5/135 1.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 5, 135°, Tube
1887630000	LSF-SMT3.5/5/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007030000	EST -SWITS.3/3/103 1.910	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 5, 135°, Tape
1885690000	LSF-SMT3.50/6/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 6, 135°, Tube
1887470000	LSF-SMT3.5/6/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 6, 135°, Tape
1885220000	LSF-SMT3.50/6/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 6, 135°, Tube
1887640000	LSF-SMT3.5/6/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 6, 135°, Tape
1885700000	LSF-SMT3.50/7/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
4007400000	LOE OMTO FIZMOS O SD	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 7, 135°, Tube
1887480000	LSF-SMT3.5/7/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885230000	LSF-SMT3.50/7/135 1.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 7, 135°, Tape PCB terminal, Push In, Reflow solder connection, Clamping range,
1003230000	LSF-SW13.50/7/135 1.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 7, 135°, Tube
1887650000	LSF-SMT3.5/7/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
100700000	201 011110.0777100 1.010	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 7, 135°, Tape
1885710000	LSF-SMT3.50/8/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 8, 135°, Tube
1887490000	LSF-SMT3.5/8/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 8, 135°, Tape
1885240000	LSF-SMT3.50/8/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 8, 135°, Tube
1887660000	LSF-SMT3.5/8/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
400570000	LOE OMTO 50/0/405 0.5	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 8, 135°, Tape
1885720000	LSF-SMT3.50/9/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 9, 135°, Tube
1887500000	LSF-SMT3.5/9/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007500000	LSF-SW13.3/9/133 3.3K	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 9, 135°, Tape
1887670000	LSF-SMT3.5/9/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007070000	201 011110:0707100 1:010	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 9, 135°, Tape
1885730000	LSF-SMT3.50/10/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 10, 135°, Tube
1887510000	LSF-SMT3.5/10/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 10, 135°, Tape
1885260000	LSF-SMT3.50/10/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 10, 135°, Tube
1887680000	LSF-SMT3.5/10/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
4005740000	LOE OMTO FORM MOR OF	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 10, 135°, Tape
1885740000	LSF-SMT3.50/11/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 11, 135°, Tube
1887520000	LSF-SMT3.5/11/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range,
1007 020000	LOT -OWITO.5/11/105 0.01	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 11, 135°, Tape
1885270000	LSF-SMT3.50/11/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 11, 135°, Tube
		•

1887690000	LSF-SMT3.5/11/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 11, 135°, Tape
1885750000	LSF-SMT3.50/12/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
400750000	LOE OMTO 5/40/405 0 5D	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tube
1887530000	LSF-SMT3.5/12/135 3.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 12, 135°, Tape
1885280000	LSF-SMT3.50/12/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 12, 135°, Tube
1887700000	LSF-SMT3.5/12/135 1.5R	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 12, 135°, Tape
1885760000	LSF-SMT3.50/13/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100500000	LCE CMT2 F0/42/42F 4 F	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube
1885290000	LSF-SMT3.50/13/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1885770000	LSF-SMT3.50/14/135 3.5	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 13, 135°, Tube PCB terminal, Push In, Reflow solder connection, Clamping range,
1003//0000	LSF-SW13.50/14/135 3.5	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 14, 135°, Tube
1885300000	LSF-SMT3.50/14/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1003300000	EST -SW113.30/14/133 1.3	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 14, 135°, Tube
1885780000	LSF-SMT3.50/15/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1003700000	LOI -0W13.30/13/133 3.3	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 15, 135°, Tube
1885310000	LSF-SMT3.50/15/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1000010000	201 01110.007107100 1.0	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 15, 135°, Tube
1885790000	LSF-SMT3.50/16/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 16, 135°, Tube
1885320000	LSF-SMT3.50/16/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 16, 135°, Tube
1885800000	LSF-SMT3.50/17/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 17, 135°, Tube
1885330000	LSF-SMT3.50/17/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
1005010000	LOE OMTO 50/40/405 0 5	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 17, 135°, Tube
1885810000	LSF-SMT3.50/18/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 18, 135°, Tube
1885340000	LSF-SMT3.50/18/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 18, 135°, Tube
1885820000	LSF-SMT3.50/19/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 19, 135°, Tube
1885350000	LSF-SMT3.50/19/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 19, 135°, Tube
1885830000	LSF-SMT3.50/20/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100000000	EGI GW10.00/20/100 0.0	max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 20, 135°, Tube
1885360000	LSF-SMT3.50/20/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 20, 135°, Tube
1885840000	LSF-SMT3.50/21/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 21, 135°, Tube
1885370000	LSF-SMT3.50/21/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 21, 135°, Tube
1885850000	LSF-SMT3.50/22/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 22, 135°, Tube
1885380000	LSF-SMT3.50/22/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
100000000	LOI -01911 0.30/22/133 1.3	max.: 1.5 mm ² , Pitch: 3.50 mm, No. of poles: 22, 135°, Tube
1885860000	LSF-SMT3.50/23/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range,
		max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 23, 135°, Tube

1885390000	LSF-SMT3.50/23/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 23, 135°, Tube
1885870000	LSF-SMT3.50/24/135 3.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm², Pitch: 3.50 mm, No. of poles: 24, 135°, Tube
1885400000	LSF-SMT3.50/24/135 1.5	PCB terminal, Push In, Reflow solder connection, Clamping range, max.: 1.5 mm ² . Pitch: 3.50 mm. No. of poles: 24, 135°. Tube

